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International Journal for Research in Applied Science & Engineering Technology (IJRASET) Implementation of High Speed Full Adder Using DTMOS

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Abstract: The power dissipation is a major problem in electronic devices. The importance for Power Management Integrated Circuit (PMIC) is emphasized as battery-powered portable electronics such as smart phone are commonly used. DTMOS technique meets the requirement for the low voltage and high-speed circuits. Due to larger current driving capacity and low leakage current, DTMOS is attractive for low power applications. So in this paper full adder design has been implemented using DTMOS technology and calculated its power dissipation and delay and compare this adder with CMOS adder using cadence tool.

Keywords - Full Adder, DTMOS, Low Power, CMOS

I. INTRODUCTION

The market demand for transferable and efficient electronic devices have pushed the industry to intend chip with high compactness, low power consumption and better performance. To obtain these goals the technology range of the CMOS has to face constant downscaling. As the technology is being reduced day by day with the reduction of channel size i.e. length of the MOSFET, the other parameter dimensions also need to be minimized. For analog and digital circuits, it is an important part to make circuits that consume less power. By using existing design methodology to make low power circuits, the applied voltage at least should be equal to the sum of threshold voltage of n-type and p-type circuits.

In DTMOS technique bulk terminal is connected to the gate terminal is a capable method for achieving superior performance without even modifying the present configuration of MOSFET. This is the chief advantage of DTMOS as it is fully compatible with the conventional CMOS process.

In this paper an adder has been implemented that is one of the most important apparatus of a central processing unit. Because it is not only used in adding of bits but also in several other processes like address calculation, subtraction, division and multiplication. The adders are very important part of circuits because they used to determine the speed, delay and power of the systems so adders that consume less power are always preferable. A single-bit full adder can be fully characterized by the below equations:

$$Sum = (A \oplus B) \oplus C_{in}$$

$$C_{out} = A \cdot B + (A \oplus B) \cdot C_{in}$$

The rest of the paper is organized as follows. An overview of the DTMOS technology which has been using in the implementation of full adder is in section II. A full adder circuit using DTMOS is presented in section III. Simulation results are presented in section IV. Conclusion remarks are given in section V.

II. OVER VIEW OF DTMOS TECHNOLOGY

The DTMOS technique was first invented in 1994. As there are several circuit applications that have been designed till now. But the DTMOS technique is mainly used technique in digital circuits in which MOSFET's gate and body are tied together. As it has very great advantage of MOSFET as it reduces the leakage current and provides high threshold voltage during off state and shows low threshold voltage during on state to increase the current driving capabilities of the circuit. This technique can also be used in bulk CMOS technology for applications of analog circuit. However, in analog circuits body terminal of the MOSFET transistor is used as a forth terminal.

In DTMOS, Figure 1, to dynamically adjust the threshold voltage of the device, the gate voltage and the substrate voltage of eac transistor is dynamically adjusted. DTMOS devices work on the principle of dual threshold logic hence these are efficient devices. Whenever DTMOS transistor is ON, its threshold voltage is decreases, current increases and propagation delay also decreases. Similarly when DTMOS transistor is OFF, its threshold voltage increases, leakage current reduces and power consumption also

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minimizes. DTMOS provides less delay with increased speed, hence it is a great technique than traditional body biasing in the subthreshold region.



Figure 1: DTMOS Structure

Figure 2 shows the schematic of DTCMOS inverter. Due to the body effect, during the different modes of operation, threshold voltage of DTMOS can be altered accordingly. When input supply 'IN' is grounded, PMOS is in 'ON' state with low V_{th} and with regular V_{th} NMOS is in 'OFF' state. As due to low V_{th} of PMOS, it works in active mode operation and the circuit goes from low to high with lesser propagation delay. When IN is connected to supply voltage exactly opposite situation takes place. As diode circuit's built-in potential limits the supply voltage of DTMOS. So for low voltages (0.6-V and below), this technique can be used with higher speed.



Figure: 2: Schematic of DTMOS inverter

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III. FULL ADDER USING DTMOS TECHNOLOGY

The adder is one of the most basic parts of a processor circuit, as Arithmetic Logic Unit (ALU), floating-point unit contains the adder circuit. Adder circuit also uses for address calculation in cache or memory access applications. With Increase in demand for low power and portable electronic devices such as mobile phones and laptop computers needs power efficient VLSI circuits. of NMOS and PMOS transistor cells are being used to build this adder cell. To realize the full adder circuit logic equation (1) and



Figure 3: Conventional CMOS Full Adder

Now the same full adder circuit is implemented using DTMOS technology as shown in figure 4. The circuit shown in figure 3 and figure 4 has been designed using Cadence Virtuoso tool with 180nm technology.

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Figure 4: Proposed Full Adder using DTMOS Technology

IV. SIMULATION AND RESULT

The 1-bit full adder has been simulated at 180nm technology. Cadence Virtuoso software platform is use to perform the circuits. The Input voltage (V_{dd}) of 0.6 and 0.4 is applied for the conventional CMOS and proposed DTMOS full adder circuits. The comparison results of DTMOS and CMOS have been shown in Table 1.

 Table -1 Simulation Result: Show the comparison of Average Power, Propagation Delay and Power delay Product of 28T adder circuit using DTMOS and CMOS technology.

Technology	Voltage (V _{dd})	PARAMETERS		
	(/	Average Power	Delay	Power Delay
		(Microwatt)	(nanoseconds)	Product(in femto)
DTMOS	0.6V	204.1	8.862	1808.73
DTMOS	0.4V	.6698	19.89	13.322
CMOS	0.6V	.3115	149.0	464.135
CMOS	0.4V	.04316	45.78	19.7586

As from results shown in Table 1, DTMOS shows lesser delay and delay power product but it consumes more power as compared to CMOS. Hence to get lesser delay with more speed as compared to traditional body biasing scheme, DTMOS is a great and efficient scheme. While Operating at lower voltages, Dynamic threshold MOS (DTMOS) circuits provide high current driving capabilities and low leakage power as compared to CMOS circuits,.

V. CONCLUSION

The properties of the full adder circuits largely define the performance of digital VLSI applications employed in various systems. In this paper 28T full adder has been implemented using DTMOS technology and has been compared with conventional CMOS adder. Adder circuits has been implemented in cadence virtuoso tool at 180nm technology and from comparison results it shows that the DTMOS adder shows a good many advantages over CMOS adder in terms of power, delay and power delay product (PDP).

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